MOSFETs Silicon N-channel MOS (U-MOS ₩-H)

TPN2010FNH

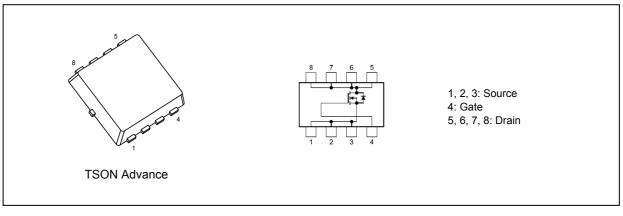
1. Applications

- High-Efficiency DC-DC Converters
- Switching Voltage Regulators

2. Features

- (1) High-speed switching
- (2) Small gate charge: $Q_{SW} = 2.6 \text{ nC}$ (typ.)
- (3) Low drain-source on-resistance: $R_{DS(ON)} = 168 \text{ m}\Omega \text{ (typ.)} (V_{GS} = 10 \text{ V})$
- (4) Low leakage current: I_{DSS} = 10 μ A (max) (V_{DS} = 250 V)
- (5) Enhancement mode: V_{th} = 2.0 to 4.0 V (V_{DS} = 10 V, I_D = 0.2 mA)

3. Packaging and Internal Circuit



4. Absolute Maximum Ratings (Note) ($T_a = 25 \,^{\circ}C$ unless otherwise specified)

Characteris	stics		Symbol	Rating	Unit
Drain-source voltage			V _{DSS}	250	V
Gate-source voltage			V _{GSS}	±20]
Drain current (DC)	(Silicon limit)	(Note 1), (Note 2)	I _D	9.9	A
Drain current (DC)	(Continuous)	(Note 1)	I _D	5.6	1
Drain current (pulsed)	(t = 1 ms)	(Note 1)	I _{DP}	19	
Power dissipation	(T _c = 25 °C)		PD	39	W
Power dissipation	(t = 10 s)	(Note 3)	PD	1.9	1
Power dissipation	(t = 10 s)	(Note 4)	PD	0.7	
Single-pulse avalanche energy		(Note 5)	E _{AS}	34	mJ
Avalanche current			I _{AR}	5.6	A
Channel temperature			T _{ch}	150	°C
Storage temperature			T _{stg}	-55 to 150	1

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Start of commercial production 2013-10 2014_02_25

5. Thermal Characteristics

Characteristics			Symbol	Max	Unit
Channel-to-case thermal resistance	(T _c = 25 °C)		R _{th(ch-c)}	3.20	°C/W
Channel-to-ambient thermal resistance	(t = 10 s)	(Note 3)	R _{th(ch-a)}	65.7	
Channel-to-ambient thermal resistance	(t = 10 s)	(Note 4)	R _{th(ch-a)}	178	

Note 1: Ensure that the channel temperature does not exceed 150 °C.

Note 2: Limited by silicon chip capability.

Note 3: Device mounted on a glass-epoxy board (a), Figure 5.1

Note 4: Device mounted on a glass-epoxy board (b), Figure 5.2

Note 5: V_DD = 60 V, T_ch = 25 °C (initial), L = 1.8 mH, I_{AR} = 5.6 A

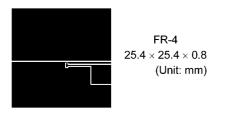


Fig. 5.1 Device Mounted on a Glass-Epoxy Board (a)

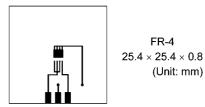


Fig. 5.2 Device Mounted on a Glass-Epoxy Board (b)

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.

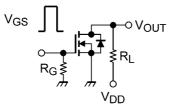
6. Electrical Characteristics

6.1. Static Characteristics (T_a = 25 °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current	I _{GSS}	V_{GS} = ±20 V, V_{DS} = 0 V	_	_	±0.1	μA
Drain cut-off current	I _{DSS}	V _{DS} = 250 V, V _{GS} = 0 V			10	
Drain-source breakdown voltage	V _{(BR)DSS}	I _D = 10 mA, V _{GS} = 0 V	250		_	V
	V _{(BR)DSX}	I _D = 10 mA, V _{GS} = -20 V	175	_	_	
Gate threshold voltage	V _{th}	V _{DS} = 10 V, I _D = 0.2 mA	2.0		4.0	
Drain-source on-resistance	R _{DS(ON)}	V _{GS} = 10 V, I _D = 2.8 A		168	198	mΩ

6.2. Dynamic Characteristics ($T_a = 25$ °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Input capacitance	C _{iss}	V _{DS} = 100 V, V _{GS} = 0 V, f = 1 MHz	_	460	600	pF
Reverse transfer capacitance	C _{rss}		—	3.0	50	
Output capacitance	C _{oss}		_	45	_	
Gate resistance	rg	—	_	4.0	6.0	Ω
Switching time (rise time)	t _r	See Fig. 6.2.1	_	5.2	_	ns
Switching time (turn-on time)	t _{on}			14	_	
Switching time (fall time)	t _f		_	4.5	_	
Switching time (turn-off time)	t _{off}		_	19	_	



$$\begin{split} V_{DD} &\approx 100 \ V \\ V_{GS} &= 0 \ V/10 \ V \\ I_D &= 2.8 \ A \\ R_L &= 35.7 \ \Omega \\ R_G &= 4.7 \ \Omega \\ Duty &\leq 1 \ \%, \ t_w = 10 \ \mu s \end{split}$$

Fig. 6.2.1 Switching Time Test Circuit

6.3. Gate Charge Characteristics ($T_a = 25$ °C unless otherwise specified)

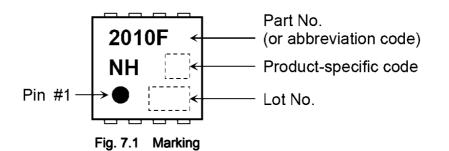
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Total gate charge (gate-source plus gate-drain)	Qg	$V_{DD} \approx 100 \text{ V}, V_{GS} \text{ = } 10 \text{V}, \text{I}_{D} \text{ = } 5.6 \text{A}$	_	7.0	—	nC
Gate-source charge 1	Q _{gs1}		—	2.4	_	nC
Gate-drain charge	Q _{gd}		_	1.5	_	
Gate switch charge	Q _{SW}			2.6		

6.4. Source-Drain Characteristics (Ta = 25 °C unless otherwise specified)

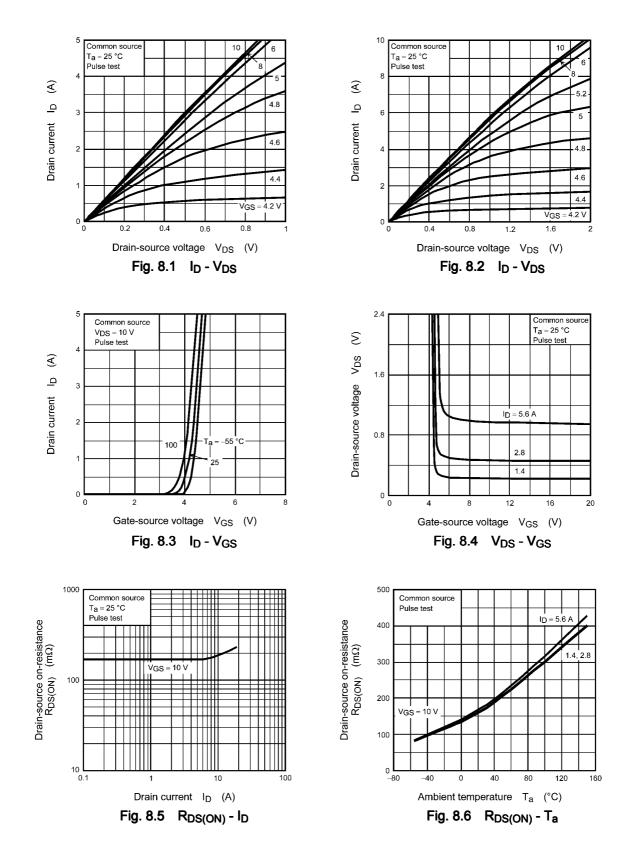
Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Reverse drain current (pulsed)	(Note 6)	I _{DRP}	—	_	_	19	А
Diode forward voltage		V _{DSF}	I _{DR} = 5.6 A, V _{GS} = 0 V	_		-1.2	V

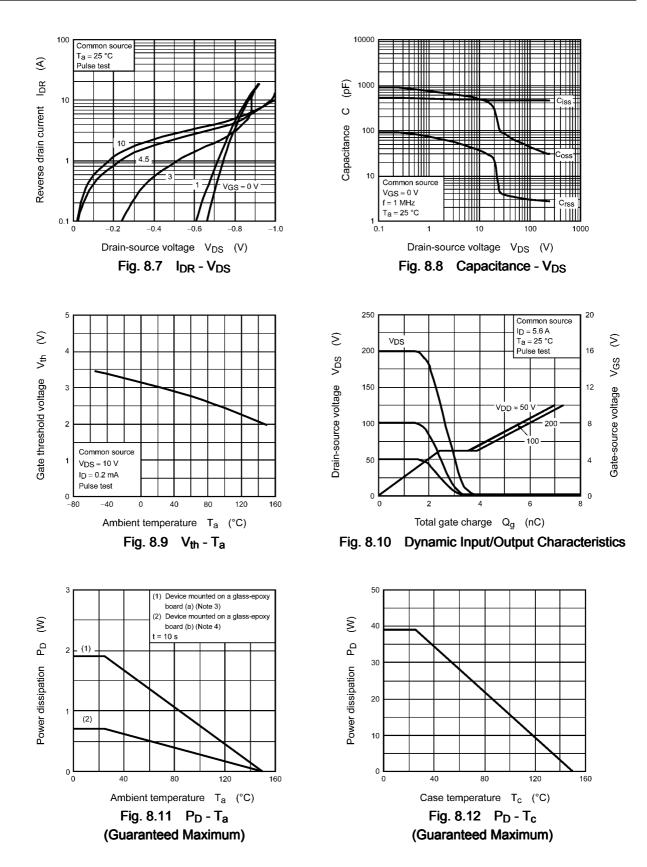
Note 6: Ensure that the channel temperature does not exceed 150 °C.

7. Marking



8. Characteristics Curves (Note)







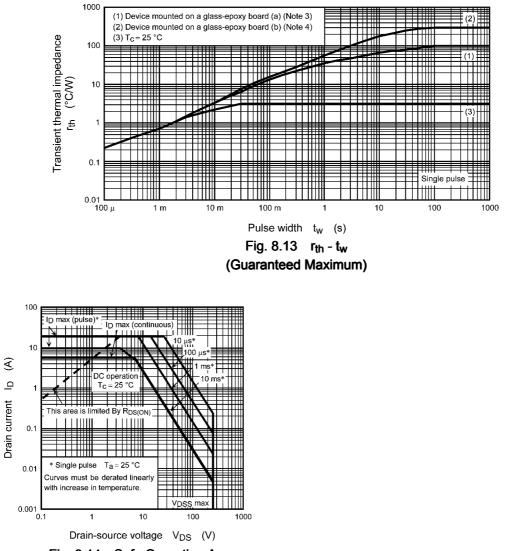


Fig. 8.14 Safe Operating Area (Guaranteed Maximum)

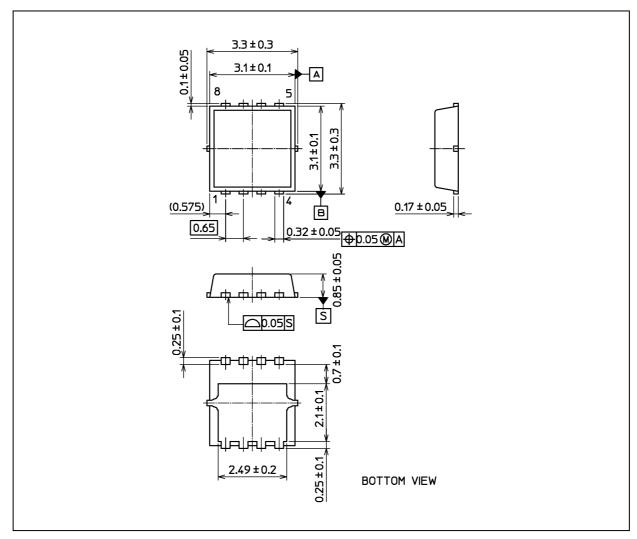
Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



TPN2010FNH

Package Dimensions

Unit: mm



Weight: 0.02 g (typ.)

Package Name(s)
TOSHIBA: 2-3X1S
Nickname: TSON Advance

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